



ORIENTAL  
SEMICONDUCTOR

GreenMOS™

## OSG60R1K2xF\_Datasheet



# Enhancement Mode N-Channel Power MOSFET

## Features

- ◆ Low  $R_{DS(on)}$  & FOM
- ◆ Extremely low switching loss
- ◆ Excellent stability and uniformity
- ◆ Easy to drive

## Applications

- ◆ Lighting
- ◆ Hard switching PWM
- ◆ Server power supply
- ◆ Charger

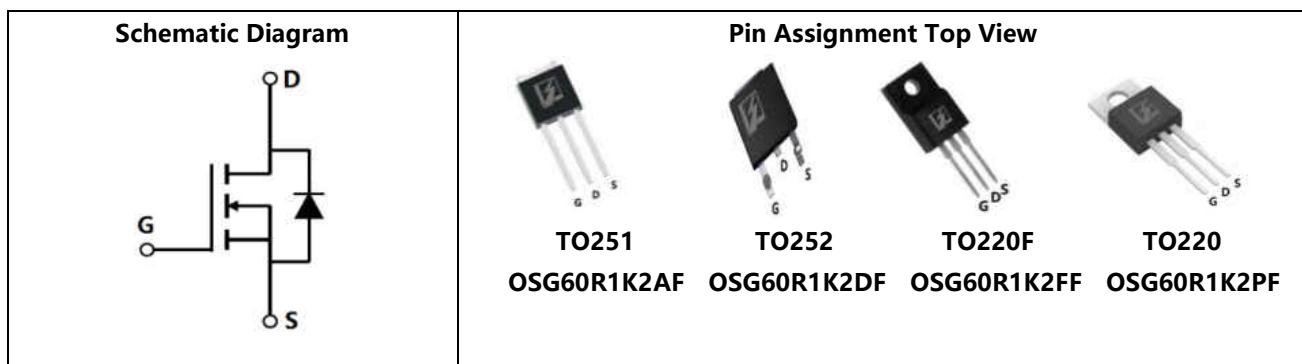


## ■ General Description

OSG60R1K2xF use advanced GreenMOS™ technology to provide low  $R_{DS(ON)}$ , low gate charge, fast switching and excellent avalanche characteristics. This device is suitable for active power factor correction and switching mode power supply applications.

◆ $V_{DS}$ , min@ $T_{jmax}$	650 V
◆ $I_D$ , pulse	12 A
◆ $R_{DS(ON)}$ , max @ $V_{GS}=10$ V	1.2 Ω
◆ $Q_g$	6.8 nC

## ■ Schematic and Package Information



## ■ Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain source voltage	$V_{DS}$	600	V
Gate source voltage	$V_{GS}$	$\pm 30$	V
Continuous drain current <sup>1)</sup> , $T_c=25^\circ\text{C}$	$I_D$	4	A
Continuous drain current <sup>1)</sup> , $T_c=100^\circ\text{C}$		2.5	
Pulsed drain current <sup>2)</sup> , $T_c=25^\circ\text{C}$	$I_{D, \text{pulse}}$	12	A
Power dissipation <sup>3)</sup> for TO251, TO252, TO220, $T_c=25^\circ\text{C}$	$P_D$	28.4	W
Power dissipation <sup>3)</sup> for TO220F, $T_c=25^\circ\text{C}$		24	
Single pulsed avalanche energy <sup>5)</sup>	$E_{AS}$	100	mJ
MOSFET dv/dt ruggedness, $V_{DS}=0...480$ V	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS}=0...480$ V, $I_{SD} \leq I_D$	dv/dt	15	V/ns
Operation and storage temperature	$T_{stg}, T_j$	-55 to 150	°C



## ■ Thermal Characteristics

Parameter	Symbol	Value		Unit
		TO251/TO252/TO220	TO220F	
Thermal resistance, junction-case	R <sub>θJC</sub>	4.4	5.2	°C/W
Thermal resistance, junction-ambient <sup>4)</sup>	R <sub>θJA</sub>	62	62.5	°C/W

## ■ Electrical Characteristics at T<sub>j</sub>=25 °C unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	BV <sub>DSS</sub>	600			V	V <sub>GS</sub> =0 V, I <sub>D</sub> =250 μA
		650	750			V <sub>GS</sub> =0 V, I <sub>D</sub> =250 μA, T <sub>j</sub> =150 °C
Gate threshold voltage	V <sub>GS(th)</sub>	2.0		4.0	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250 μA
Drain-source on-state resistance	R <sub>DS(ON)</sub>		1.0	1.2	Ω	V <sub>GS</sub> =10 V, I <sub>D</sub> =2 A
			2.4			V <sub>GS</sub> =10 V, I <sub>D</sub> =2 A, T <sub>j</sub> =150 °C
Gate-source leakage current	I <sub>GSS</sub>			100	nA	V <sub>GS</sub> =30 V
				-100		V <sub>GS</sub> =-30 V
Drain-source leakage current	I <sub>DSS</sub>			1	μA	V <sub>DS</sub> =600 V, V <sub>GS</sub> =0 V

## ■ Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C <sub>iss</sub>		259.6		pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz
Output capacitance	C <sub>oss</sub>		21.3		pF	
Reverse transfer capacitance	C <sub>rss</sub>		0.9		pF	
Turn-on delay time	t <sub>d(on)</sub>		32.6		ns	V <sub>GS</sub> =10 V, V <sub>DS</sub> =400 V, R <sub>G</sub> =25 Ω, I <sub>D</sub> =4 A
Rise time	t <sub>r</sub>		18.4		ns	
Turn-off delay time	t <sub>d(off)</sub>		59.6		ns	
Fall time	t <sub>f</sub>		30		ns	



## ■ Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	$Q_g$		6.8		nC	$I_D=4\text{ A}$ , $V_{DS}=400\text{ V}$ , $V_{GS}=10\text{ V}$
Gate-source charge	$Q_{gs}$		2		nC	
Gate-drain charge	$Q_{gd}$		3.1		nC	
Gate plateau voltage	$V_{plateau}$		5.6		V	

## ■ Body Diode Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Diode forward current	$I_S$			4	A	$V_{GS} < V_{th}$
Pulsed source current	$I_{SP}$			12		
Diode forward voltage	$V_{SD}$			1.3	V	$I_S=4\text{ A}, V_{GS}=0\text{ V}$
Reverse recovery time	$t_{rr}$		157.6		ns	$V_R=400\text{ V}, I_S=4\text{ A}$ , $di/dt=100\text{ A}/\mu\text{s}$
Reverse recovery charge	$Q_{rr}$		1.06		$\mu\text{C}$	
Peak reverse recovery current	$I_{rrm}$		11.3		A	

## ■ Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3)  $P_d$  is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25\text{ }^{\circ}\text{C}$ .
- 5)  $V_{DD}=50\text{ V}$ ,  $R_G=25\text{ }\Omega$ ,  $L=20\text{ mH}$ , starting  $T_j=25\text{ }^{\circ}\text{C}$ .

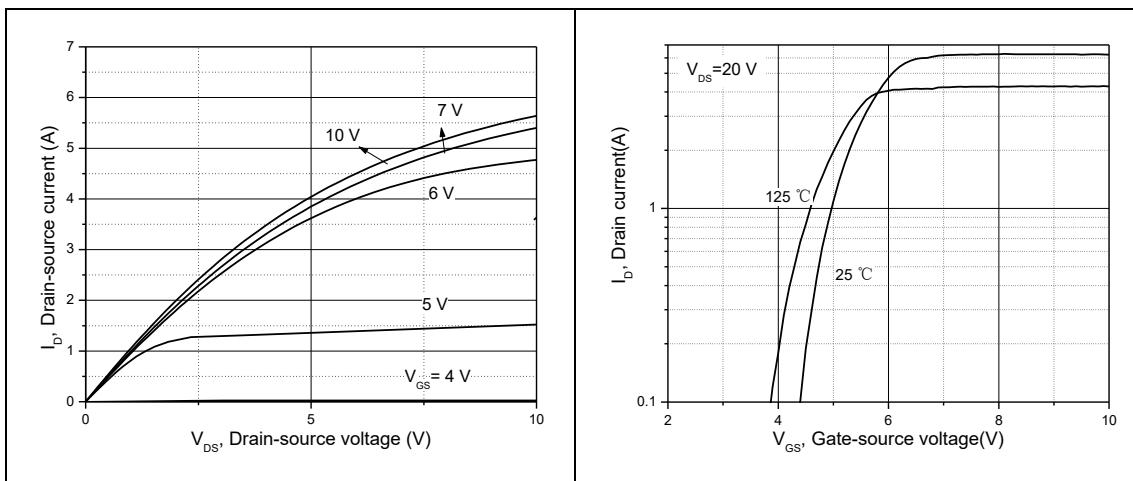
**■ Electrical Characteristics Diagrams**

Figure 1, Typ. output characteristics

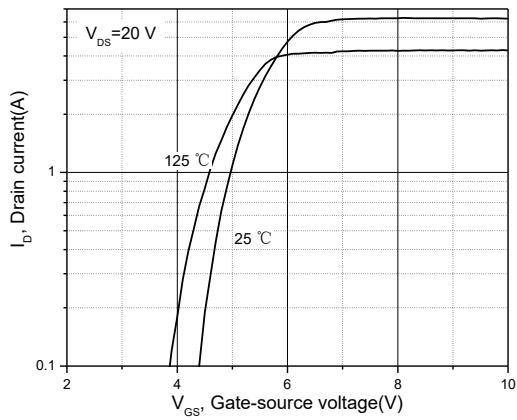


Figure 2, Typ. transfer characteristics

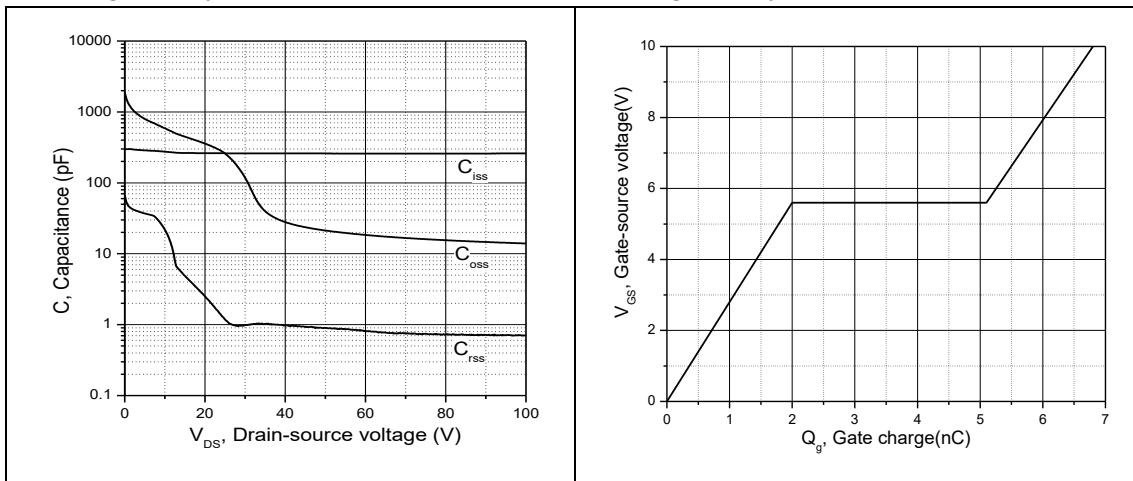


Figure 3, Typ. capacitances

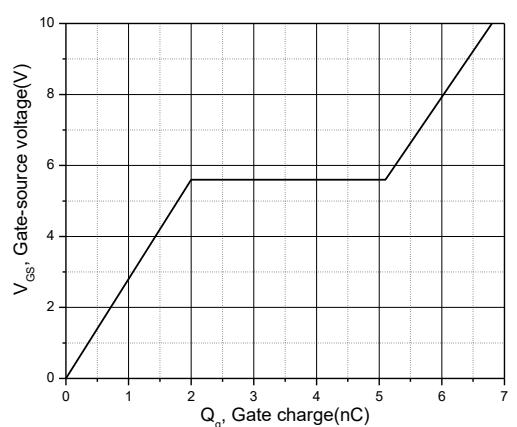


Figure 4, Typ. gate charge

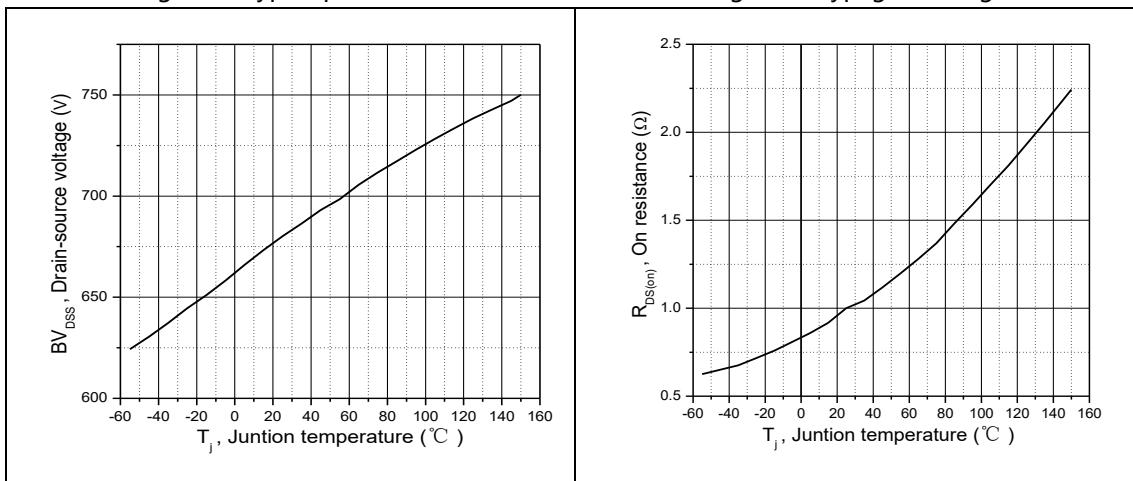


Figure 5, Drain-source breakdown voltage

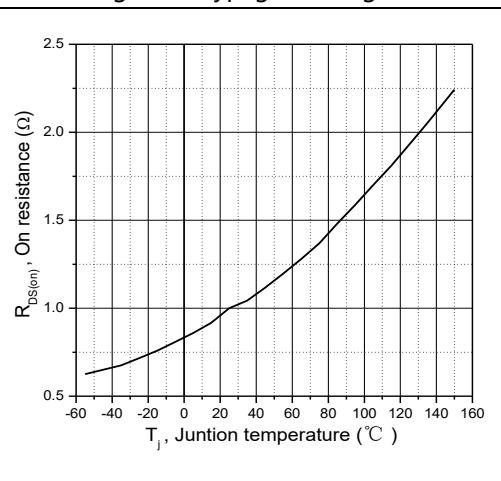


Figure 6, Drain-source on-state resistance

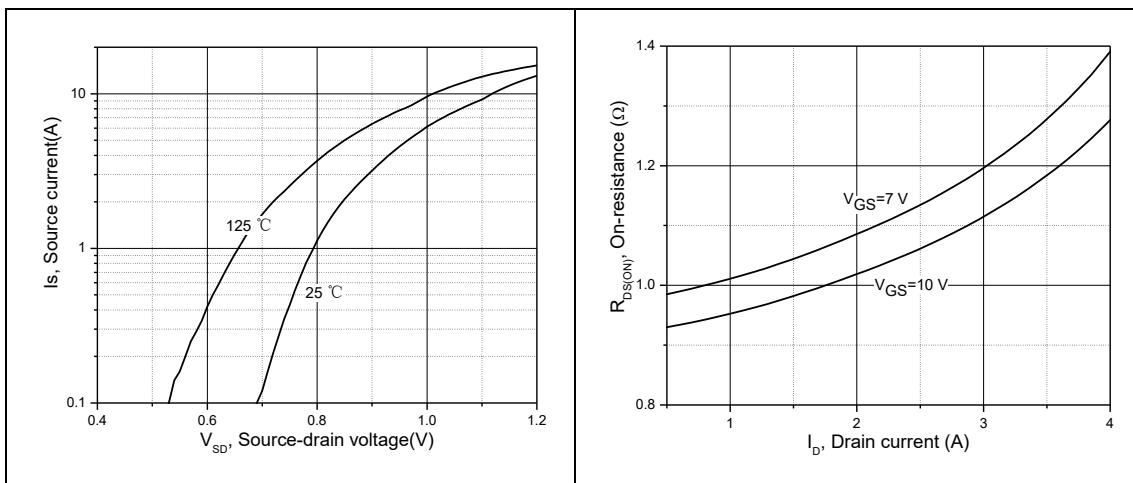


Figure 7, Forward characteristic of body diode

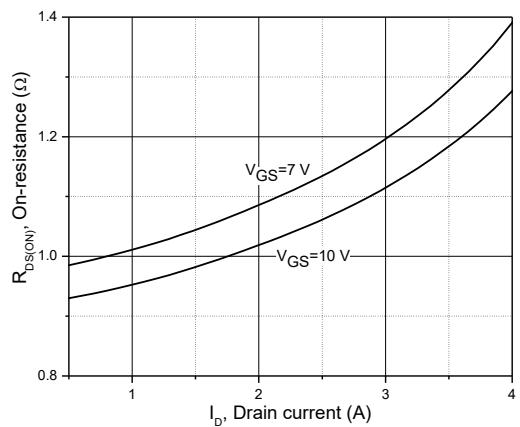


Figure 8, Drain-source on-state resistance

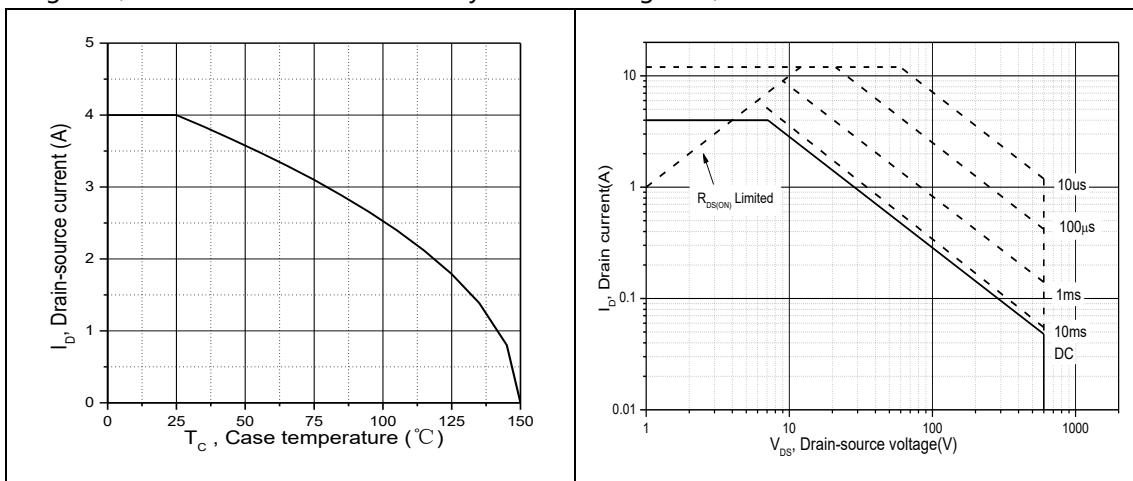
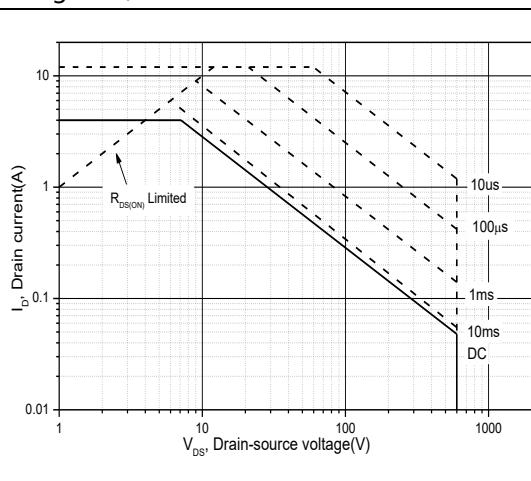
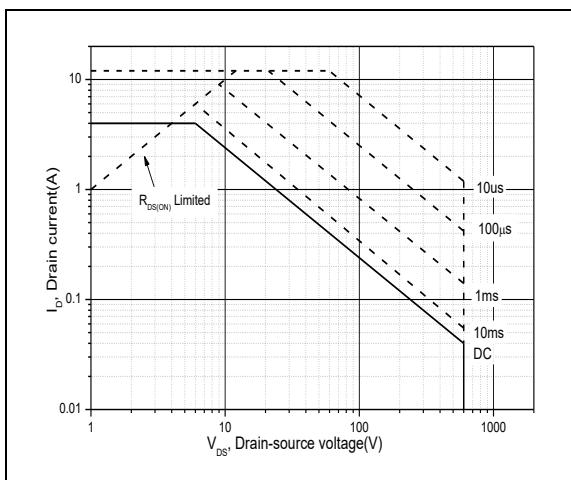


Figure 9, Drain current

Figure 10, Safe operation area for  
TO251/TO252/TO220  $T_C=25^\circ\text{C}$ Figure 11, Safe operation area for TO220F  
 $T_C=25^\circ\text{C}$

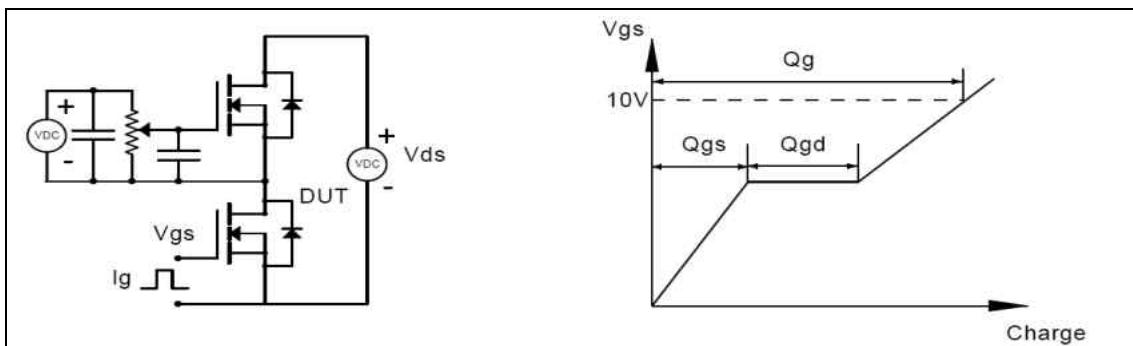
**■ Test circuits and waveforms**

Figure 1, Gate charge test circuit &amp; waveform

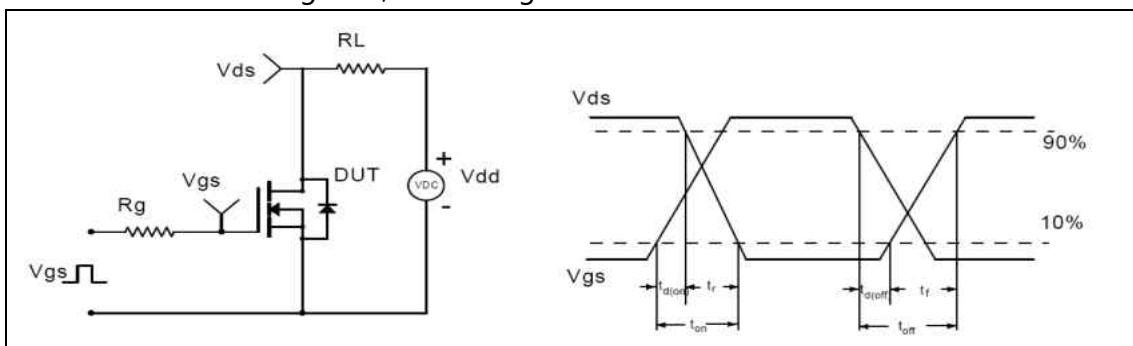


Figure 2, Switching time test circuit &amp; waveforms

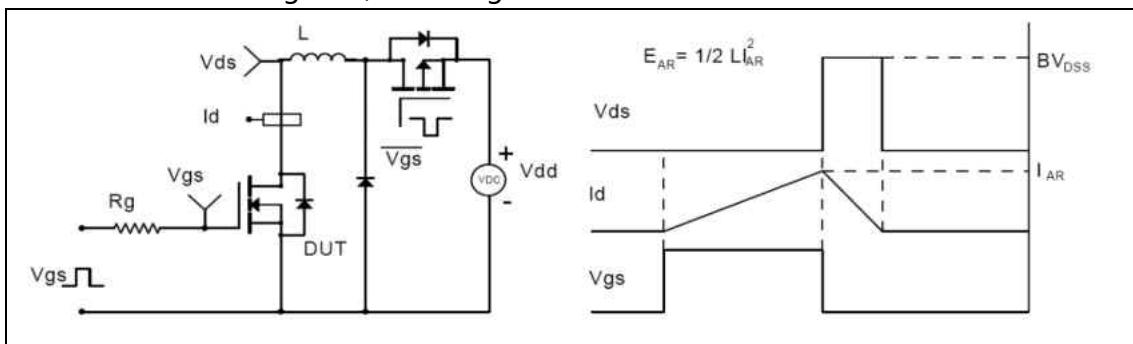


Figure 3, Unclamped inductive switching (UIS) test circuit &amp; waveforms

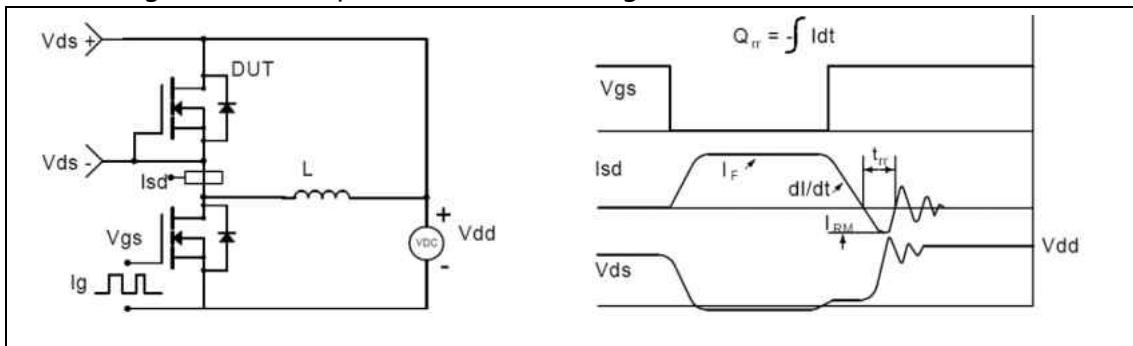
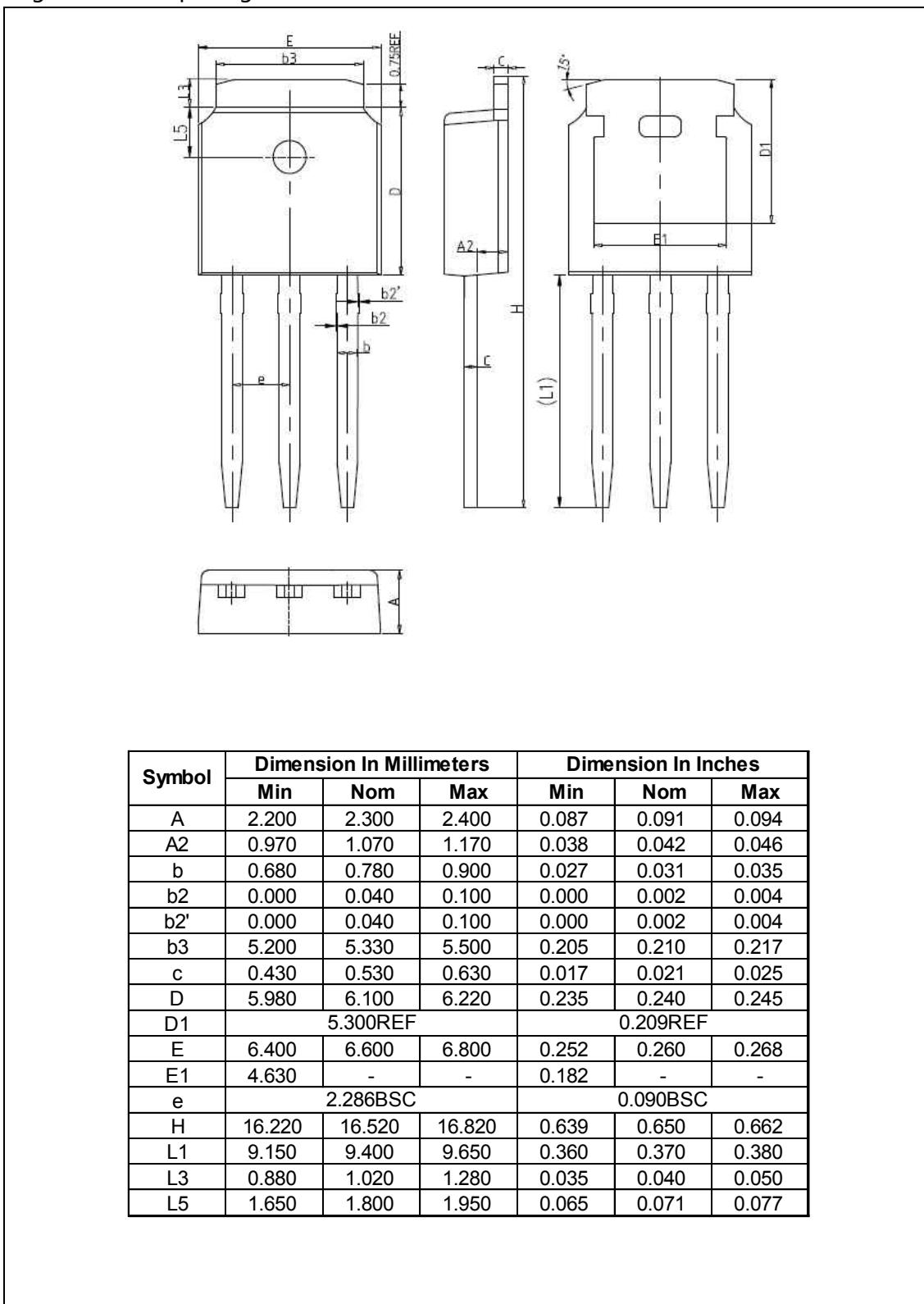


Figure 4, Diode reverse recovery test circuit &amp; waveforms

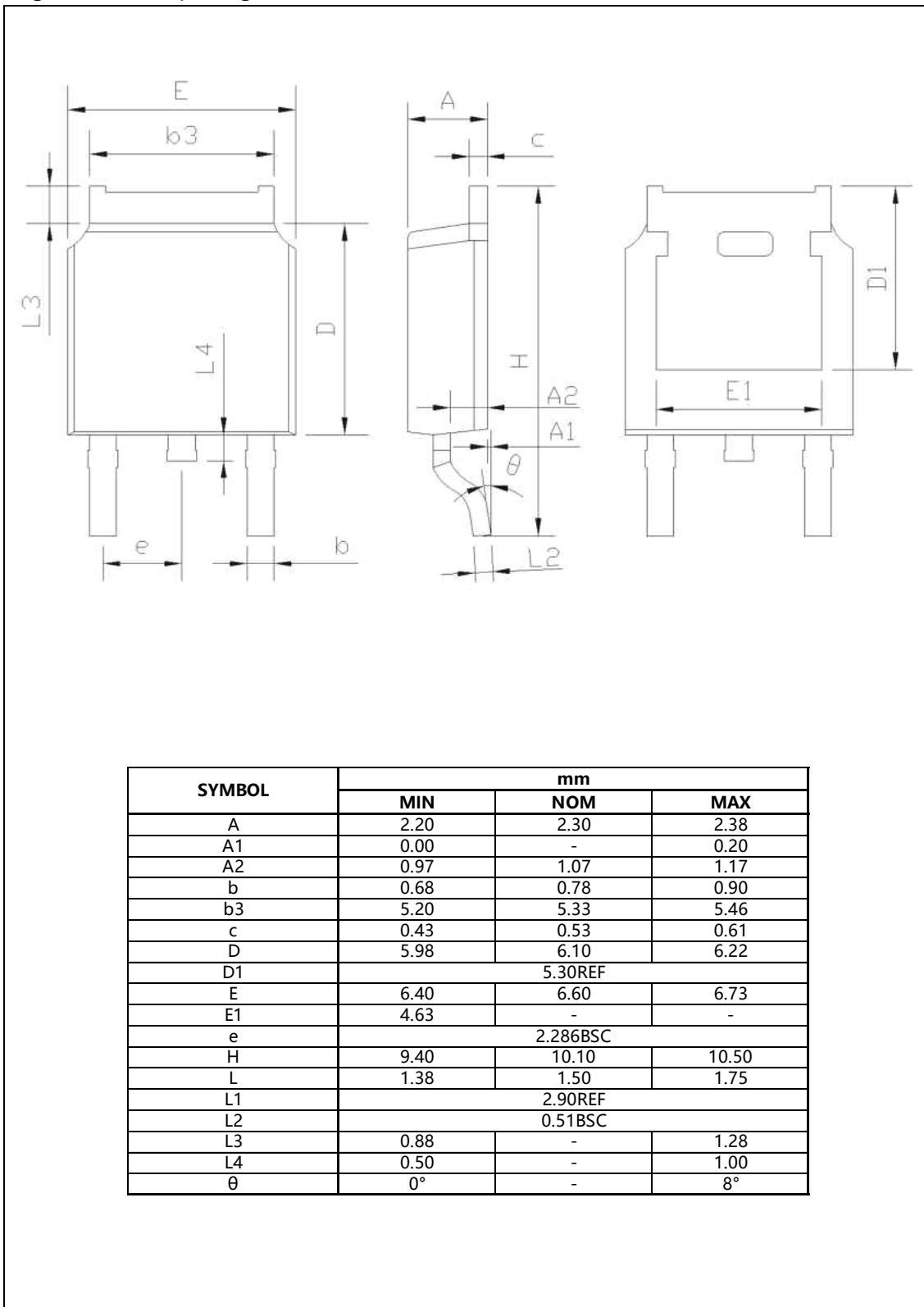
**■ Package Information**

Figure1, TO251 package outline dimension



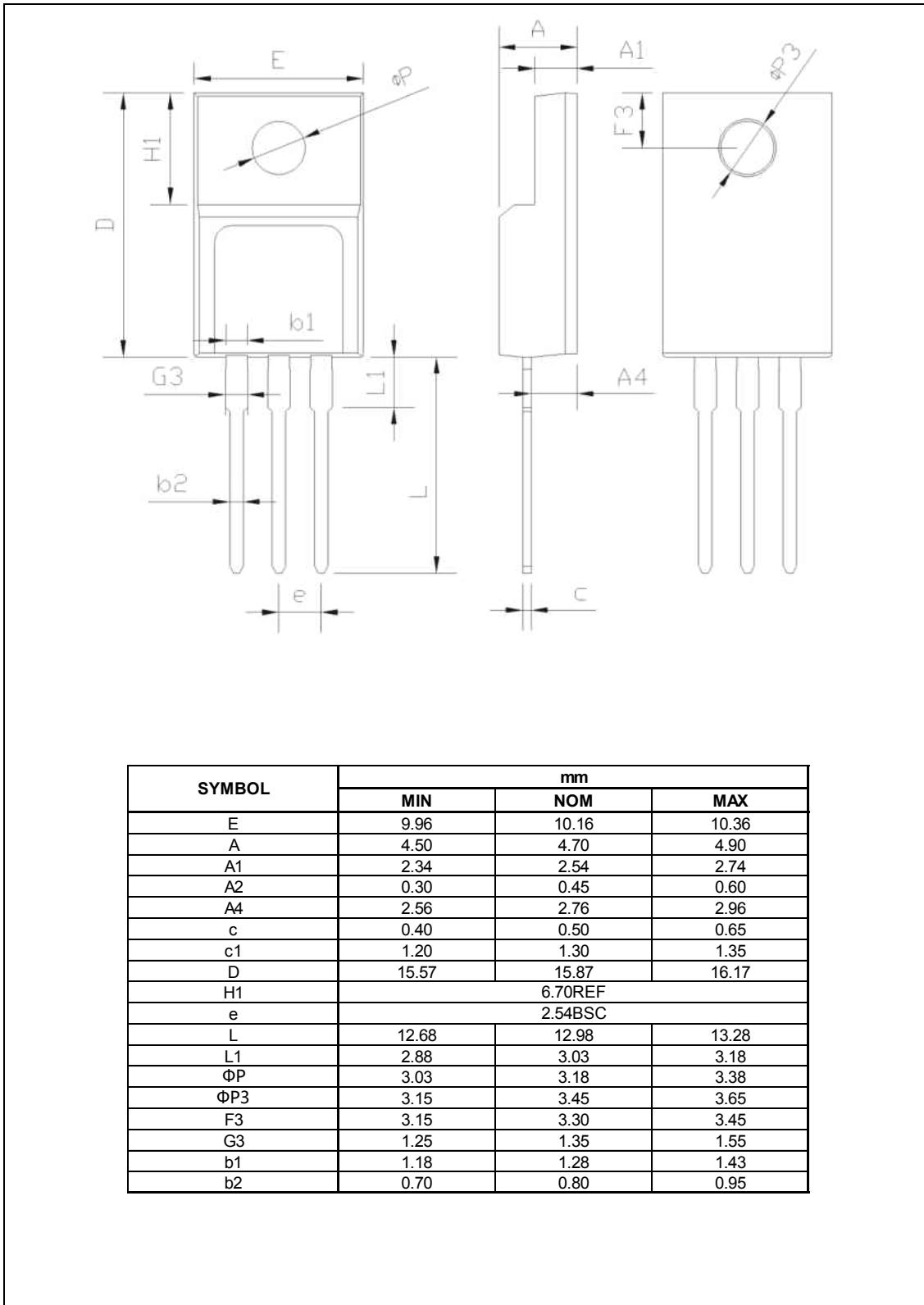
**■ Package Information**

Figure2, TO252 package outline dimension



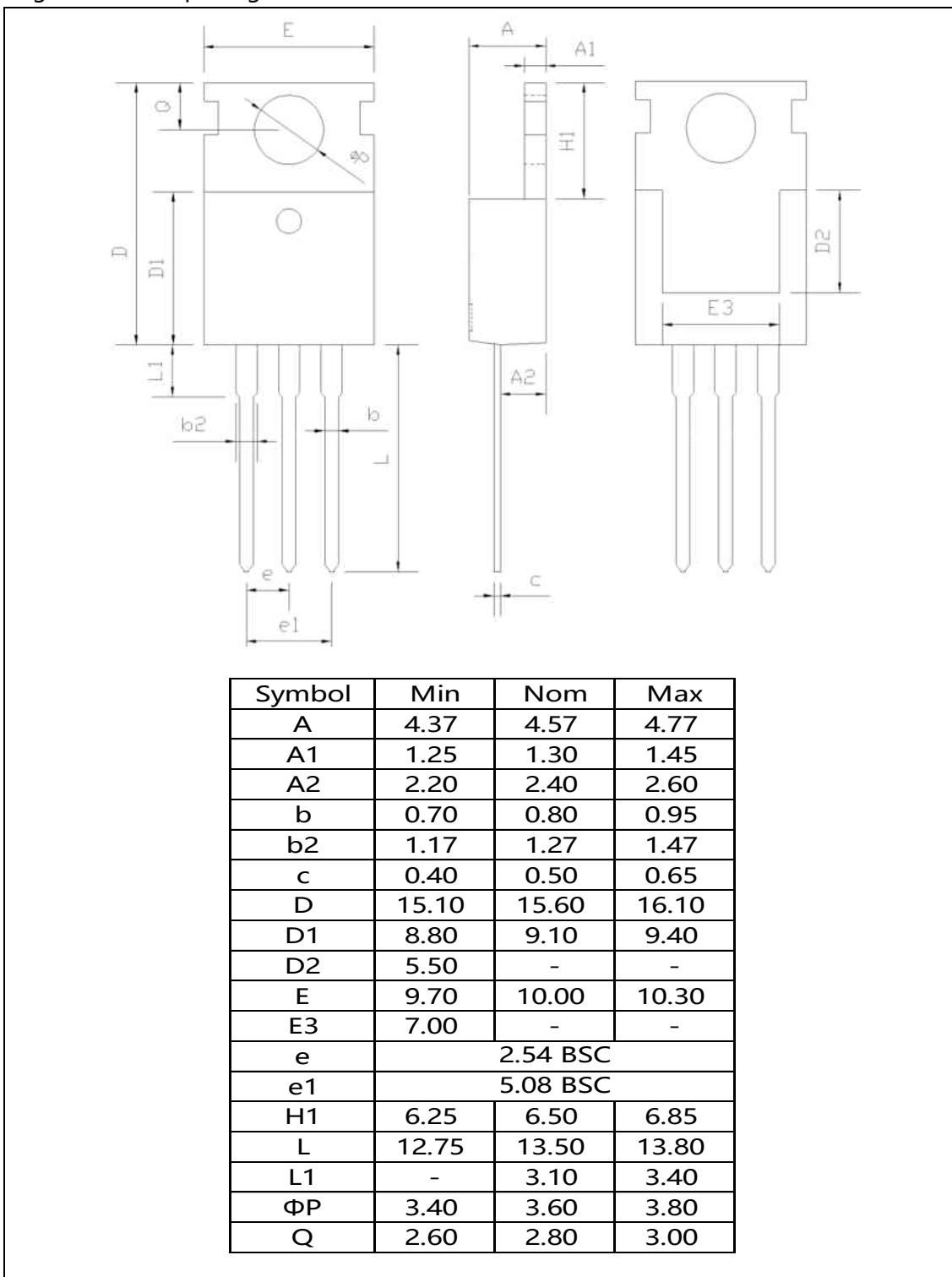
**■ Package Information**

Figure3, TO220F package outline dimension



**■ Package Information**

Figure4, TO220 package outline dimension



**■ Ordering Information**

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Package	Units/Tube	Tubes/Inner Box	Units/Inner Box	Inner Box/Carton Box	Units/Carton Box
TO251	75	66	4950	6	29700
TO220F	50	20	1000	6	6000
TO220	50	20	1000	6	6000

Package	Units/Tape	Tapes/Inner Box	Units/Inner Box	Inner Box/Carton Box	Units/Carton Box
TO252	2500	2	5000	5	25000

**■ Product Information**

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Product	Package	Pb Free	RoHS	Halogen Free
OSG60R1K2AF	TO251	yes	yes	yes
OSG60R1K2DF	TO252	yes	yes	yes
OSG60R1K2FF	TO220F	yes	yes	yes
OSG60R1K2PF	TO220	yes	yes	yes